LNJ852W83RA

Hight Bright Surface Mounting Chip LED

SV (Side View) -0.4 Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	55	mW	
Forward current	I _F	20	mA	
Pulse forward current *	I _{FP}	60	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Lighting Color

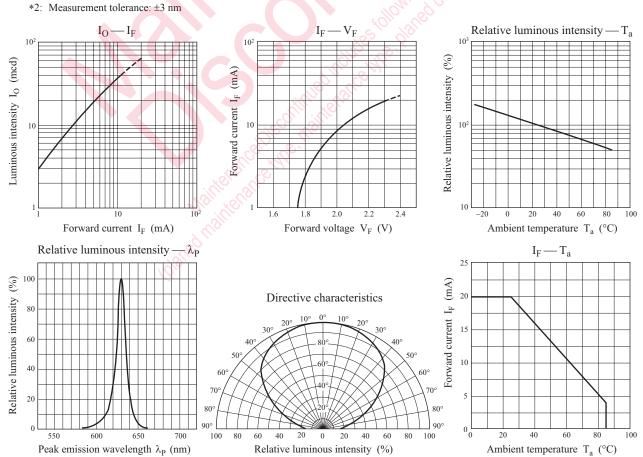
• Orange

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit Cont
Luminous intensity *1	Io	$I_F = 5 \text{ mA}$	9.0	17.0	52.5	mcd
Reverse current	I _R	$V_R = 4 V$		is the	100	μΑ
Forward voltage	V _F	$I_F = 5 \text{ mA}$		1.9	2.3	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 5 \text{ mA}$	du	630		nm
Dominant emission wavelength *2	λ_d	$I_F = 5 \text{ mA}$	615	620	627	nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$	U _{ll} .	13		nm

Note) *1: Measurement tolerance: $\pm 20\%$

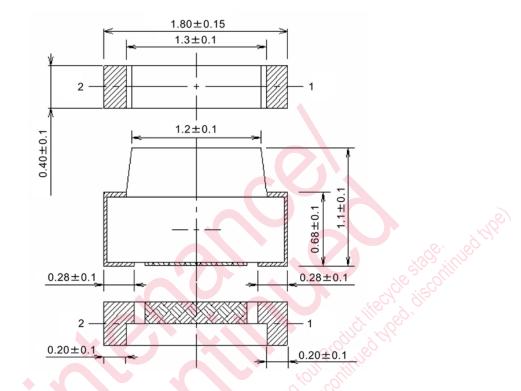


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Panasonic

Package (Unit: mm)

KLTFSN2K5200



- Pin name
 - 1: Anode
 - 2: Cathode

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